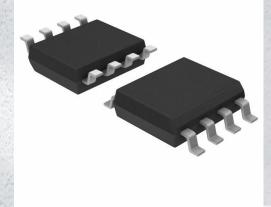


NB100ELT23LDR2G Datasheet

www.digi-electronics.com



Manufacturer	onsemi
nufacturer Product Number	NB100ELT23

Description

Detailed Description

DiGi Electronics Part Number

Man

NB100ELT23LDR2G-DG

LDR2G

IC TRANSLTR UNIDIRECTIONAL 8SOIC

Mixed Signal Translator Unidirectional 1 Circuit 2 C hannel 8-SOIC

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
NB100ELT23LDR2G	onsemi
Series:	Product Status:
100ELT	Obsolete
Translator Type:	Channel Type:
Mixed Signal	Unidirectional
Number of Circuits:	Channels per Circuit:
1	2
Output Signal:	Output Type:
LVTTL	Non-Inverted
Data Rate:	Operating Temperature:
-	-40°C ~ 85°C (TA)
Features:	Mounting Type:
	Surface Mount
Package / Case:	Supplier Device Package:
8-SOIC (0.154", 3.90mm Width)	8-SOIC
Base Product Number:	
100ELT23	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8542.39.0001	

DNSemi

3.3 V Dual Differential **LVPECL/LVDS to LVTTL Translator**

NB100ELT23L

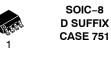
Description

The NB100ELT23L is a dual differential LVPECL/LVDS to LVTTL translator. Because LVPECL (Positive ECL) or LVDS levels are used. only +3.3 V and ground are required. The small outline 8-lead package and the dual gate design of the ELT23L makes it ideal for applications which require the translation of a clock and a data signal.

The ELT23L is available in only the ECL 100K standard. Since there are no LVPECL outputs or an external V_{BB} reference, the ELT23L does not require both ECL standard versions. The LVPECL inputs are differential. Therefore, the NB100ELT23L can accept any standard differential LVPECL/LVDS input referenced from a V_{CC} of +3.3 V.

Features

- 2.1 ns Typical Propagation Delay
- Maximum Operating Frequency > 160 MHz
- 24 mA LVTTL Outputs
- Operating Range: $V_{CC} = 3.0 \text{ V}$ to 3.6 V with GND = 0 V
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



CASE 751 TSSOP-8

SOIC-8

DT SUFFIX CASE 948R

MARKING DIAGRAMS*





= Assembly Location

= Wafer Lot

= Year

А

L

Υ

W

= Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

Device	Package	Shipping †
NB100ELT23LDTR2G	TSSOP-8 (Pb-Free)	2,500 / Tape & Reel

DISCONTINUED (Note 1)

NB100ELT23LDR2G	SOIC-8 (Pb-Free)	2,500 / Tape & Reel
NB100ELT23LDTG	TSSOP-8 (Pb-Free)	100 Units / Tube

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

1. DISCONTINUED: These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.

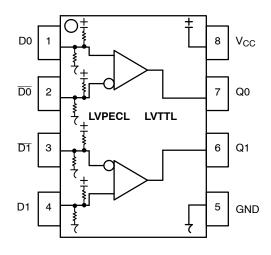


Figure 1. 8–Lead Pinout (Top View) and Logic Diagram

Table 1. PIN DESCRIPTION

PIN	FUNCTION
Q0, Q1	LVTTL Outputs
D0*, D1* D0**, D1**	Differential LVPECL Inputs
V _{CC}	Positive Supply
GND	Ground

*Pins will default to $V_{CC}/2$ when left open. If connected to a common termination voltage under no signal conditions, then the device will be susceptible to self-oscillation.

**Pins will default to 2/3 V_{CC} when left open. If connected to a common termination voltage under no signal conditions, then the device will be susceptible to self-oscillation. See AND8020, Section 6 for options.

Table 2. ATTRIBUTES

Characteristics	Value
Internal Input Pulldown Resistor D D	50 kΩ 75 kΩ
Internal Input Pullup Resistor	50 kΩ
ESD Protection Human Body Model Machine Model Charged Device Model	> 1.5 kV > 100 V > 2 kV
Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1)	Pb-Free Pkg
SOIC-8 TSSOP-8	Level 1 Level 3
Flammability Rating Oxygen Index: 28 to 34	UL 94 V–0 @ 1.25 in
Transistor Count	91 Devices
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test	·

1. For additional information, see Application Note AND8003/D.

Table 3. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	Power Supply	GND = 0 V		3.8	V
VI	Input Voltage	GND = 0 V	$V_{I} \leq V_{CC}$	3.8	V
I _{out}	Output Current	Continuous Surge		50 100	mA mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	SO-8 SO-8	190 130	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	Standard Board	SO-8	41 to 44	°C/W
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	TSSOP-8 TSSOP-8	185 140	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	Standard Board	TSSOP-8	41 to 44	°C/W
T _{sol}	Wave Solder Pb-Free	<2 to 3 sec @ 260°C		265	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 4. PECL DC CHARACTERISTICS V_{CC} = 3.3 V, GND = 0 V (Note 2)

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{CCH}	Power Supply Current (Outputs set to HIGH)	10	23	30	10	23	30	10	24	30	mA
I _{CCL}	Power Supply Current (Outputs set to LOW)	15	26	35	15	26	35	15	27	35	mA
VIH	Input HIGH Voltage	2075		2420	2075		2420	2075		2420	mV
VIL	Input LOW Voltage	1355		1675	1355		1675	1355		1675	mV
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Note 3)	1.2		3.3	1.2		3.3	1.2		3.3	V
I _{IH}	Input HIGH Current			150			150			150	μA
Ι _{ΙL}	Input LOW Current	-150			-150			-150			μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

2. All values vary 1:1 with V_{CC} . 3. V_{IHCMR} minimum varies 1:1 with V_{EE} , V_{IHCMR} max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

Table 5. TTL DC CHARACTERISTICS V_{CC} = 3.3 V, GND = 0.0 V, T_A = -40° C to 85° C

Symbol	Characteristic	Condition	Min	Тур	Max	Unit
V _{OH}	Output HIGH Voltage	I _{OH} = -3.0 mA	2.4			V
V _{OL}	Output LOW Voltage	I _{OL} = 24 mA			0.5	V
I _{OS}	Output Short Circuit Current		-180		-50	mA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

			−40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f _{max}	Maximum Frequency	160			160			160			MHz
t _{PLH} , t _{PHL}	$\begin{array}{l} \mbox{Propagation Delay to Output Differential} \\ \mbox{(Note 5)} & \mbox{C}_{L} = 20 \ \mbox{pF} \end{array}$	1.55	1.9	2.95	1.55	1.9	2.95	1.55	1.9	3.25	ns
t _{SK+ +} t _{SK} t _{SKPP}	Output-to-Output Skew++ Output-to-Output Skew- – Part-to-Part Skew (Note 6)			60 25 500			60 25 500			60 25 500	ps
t JITTER	Random Clock Jitter (RMS)		6.0	20		6.0	20		6.0	20	ps
V_{PP}	Input Voltage Swing (Differential Configuration)	150	800	1200	150	800	1200	150	800	1200	mV
t _r t _f	Output Rise/Fall Times C _L = 20 pF (0.8 V to 2.0 V)	700 300	900	1700 1250	700 300	900	1700 1250	700 300	900	1700 1250	ps

Table 6. AC CHARACTERISTICS V_{CC} = 3.3 V ±5%, GND = 0.0 V (Note 4)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

4. Measured using a 750 mV source, 50% duty cycle clock source. All loading with 500 Ω to GND, CL = 20 pF.

5. Reference ($V_{CC} = 3.3 \text{ V} \pm 5\%$; GND = 0 V). 6. Skews are measured between outputs under identical conditions.

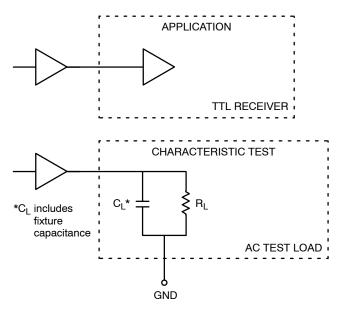


Figure 2. TTL Output Loading Used for Device Evaluation

Resource Reference of Application Notes

- AN1405/D
 ECL Clock Distribution Techniques

 AN1406/D
 Designing with PECL (ECL at +5.0 V)

 AN1503/D
 ECLinPS ™ I/O SPiCE Modeling Kit

 AN1504/D
 Metastability and the ECLinPS Family

 AN1568/D
 Interfacing Between LVDS and ECL
- AN1672/D The ECL Translator Guide
- AND8001/D Odd Number Counters Design
- AND8002/D Marking and Date Codes
- AND8020/D Termination of ECL Logic Devices
- AND8066/D Interfacing with ECLinPS
- AND8090/D AC Characteristics of ECL Devices

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-T- SEATING

PLANE

D

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

NOTES:

4.

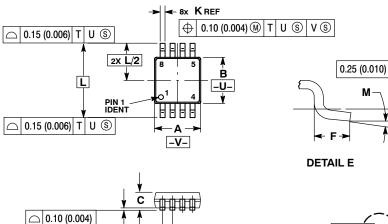
5.

PER SIDE.

SCALE 2:1

TSSOP-8 3.00x3.00x0.95 CASE 948R-02 ISSUE A

DATE 07 APR 2000



G

DETAIL E

DIMENSION A AND B ARE TO BE DETERMIN AT DATUM PLANE -W								
	MILLIN	MILLIMETERS INCHES						
DIM	MIN	MAX	MIN	MAX				
Α	2.90	3.10	0.114	0.122				
В	2.90	3.10	0.114	0.122				
C	0.80	1.10	0.031	0.043				
D	0.05	0.15	0.002	0.006				
F	0.40	0.70	0.016	0.028				
G	0.65	BSC	0.026	BSC				
K	0.25	0.40	0.010	0.016				
L	4.90	BSC		BSC				
Μ	0°	6 °	0°	6 °				

TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.

 DIMENSION A DOES NOT INCLUDE MOLD FLASH.
 DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010)

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